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# N-Channel PowerTrench<sup>®</sup> SyncFET<sup>TM</sup> 30 V, 21 A, 4.4 m $\Omega$

### Features

- Max  $r_{DS(on)}$  = 4.4 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 19 A
- Max  $r_{DS(on)}$  = 5.2 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 17.5 A
- Advanced package and silicon combination for low r<sub>DS(on)</sub> and high efficiency
- SyncFET Schottky Body Diode
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

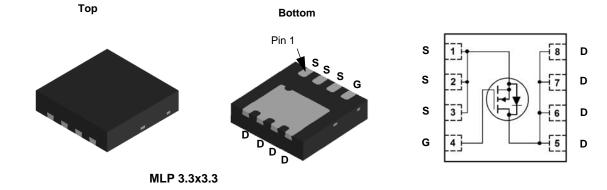


### **General Description**

The FDMC8026S has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest  $r_{\text{DS}(on)}$  while maintaining excellent switching performance.This device has the added benefit of an efficient monolithic schottky body diode.

### **Applications**

- Synchronous Rectifier for DC/DC Converters
- Notebook Vcore/GPU low side switch
- Networking Point of Load low side switch
- Telecom secondary side rectification



### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Param	eter		Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			30	V	
V <sub>GS</sub>	Gate to Source Voltage		(Note 4)	±20	V	
	Drain Current -Continuous	$T_{\rm C} = 25^{\circ}{\rm C}$		21		
I <sub>D</sub>	-Continuous	T <sub>A</sub> = 25°C	(Note 1a)	19	Α	
	-Pulsed			100		
E <sub>AS</sub>	Single Pulse Avalance Energy		(Note 3)	66	mJ	
P <sub>D</sub>	Power Dissipation	$T_{\rm C} = 25^{\circ}{\rm C}$		36	10/	
	Power Dissipation	T <sub>A</sub> = 25°C	(Note 1a)	2.4	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperation	ature Range		-55 to +150	°C	

### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case	3.4	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a	) 53	0/00

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC8026S	FDMC8026S	MLP 3.3X3.3	13 "	12 mm	3000 units

Off Chara BV <sub>DSS</sub> ΔBV <sub>DSS</sub> ΔT <sub>J</sub> I <sub>DSS</sub> I <sub>GSS</sub>	Acteristics Drain to Source Breakdown Voltage	-		Тур	Max	Units
BV <sub>DSS</sub> ΔBV <sub>DSS</sub> ΔT <sub>J</sub>						1
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$ $I_{DSS}$	Brain to boarde Breakdown Voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0 V	30			V
ΔT <sub>J</sub> I <sub>DSS</sub>	Breakdown Voltage Temperature		50			-
	Coefficient	$I_D$ = 10 mA, referenced to 25 °C		26		mV/°C
	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V			500	μA
	Gate to Source Leakage Current, Forward	$V_{GS} = 20 V, V_{DS} = 0 V$			100	nA
On Chara	acteristics					
	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 1 \text{ mA}$	1.2	1.6	3.0	V
V <sub>GS(th)</sub> ∆V <sub>GS(th)</sub>	Gate to Source Threshold Voltage		1.2	1.0	5.0	v
$\Delta T_J$	Temperature Coefficient	$I_D = 10$ mA, referenced to 25 °C		-5		mV/°C
0		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 19 A		3.8	4.4	+
-	Static Drain to Source On Resistance	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 17.5 A		4.5	5.2	mΩ
r <sub>DS(on)</sub>		$V_{GS} = 10 \text{ V}, I_D = 19 \text{ A},$ $T_J = 125 \text{ °C}$		4.5	5.8	- 11152
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 19 A		106		S
Junamia	Characteristics					
-	Characteristics				0405	-
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V,		2380	3165	pF
C <sub>oss</sub>	Output Capacitance	_f = 1 MHz		885	1175	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		0.4	100	150	pF
R <sub>g</sub>	Gate Resistance		0.1	0.7	2.5	Ω
Switching	g Characteristics					
	Turn-On Delay Time			11	20	ns
<sup>[</sup> d(on)						-
	Rise Time	V <sub>DD</sub> = 15 V, I <sub>D</sub> = 19 A,		5	10	ns
t <sub>r</sub>		$V_{DD}$ = 15 V, I <sub>D</sub> = 19 A, V <sub>GS</sub> = 10 V, R <sub>GEN</sub> = 6 Ω		5 30		
r d(off)	Rise Time			-	10	ns
r d(off)	Rise Time Turn-Off Delay Time			30	10 48	ns ns
<sup>t</sup> r <sup>t</sup> d(off) <sup>t</sup> f Q <sub>g</sub>	Rise Time       Turn-Off Delay Time       Fall Time	$V_{GS} = 10 \text{ V},  \text{R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V} \text{ to } 10 \text{ V}$		30 4	10 48 10	ns ns ns
t <mark>r td(off) tf Qg Qg</mark>	Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge	$V_{GS} = 10 V, R_{GEN} = 6 \Omega$		30 4 37	10 48 10 52	ns ns ns nC
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub>	Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge	$V_{GS} = 10 \text{ V},  \text{R}_{\text{GEN}} = 6  \Omega$ $V_{\text{GS}} = 0 \text{ V to } 10 \text{ V}$ $V_{\text{GS}} = 0 \text{ V to } 4.5 \text{ V}$ $V_{\text{DD}} = 15 \text{ V},$		30 4 37 18	10 48 10 52	ns ns ns nC nC
t <sub>r</sub> td(off) tf Qg Qg Qgs Qgs Qgd	Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V},  \text{R}_{\text{GEN}} = 6  \Omega$ $V_{\text{GS}} = 0 \text{ V to } 10 \text{ V}$ $V_{\text{GS}} = 0 \text{ V to } 4.5 \text{ V}$ $V_{\text{DD}} = 15 \text{ V},$		30 4 37 18 6	10 48 10 52	ns ns nC nC nC
t <sub>d(on)</sub> tr t <sub>d(off)</sub> tf Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> <b>Drain-So</b>	Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 15 \text{ V},$ $I_{D} = 19 \text{ A}$		30 4 37 18 6 6	10 48 10 52 25	ns ns nC nC nC
tr td(off) tf Qg Qg Qgs Qgd	Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $I_D = 15 \text{ V},$ $I_D = 19 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_S = 2 \text{ A}$ (Note 2)		30 4 37 18 6 6 0.6	10 48 10 52 25 	ns ns nC nC nC
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> <b>Drain-So</b> V <sub>SD</sub>	Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics         Source to Drain Diode Forward Voltage	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 15 \text{ V},$ $I_{D} = 19 \text{ A}$		30 4 37 18 6 6 6 0.6 0.8	10 48 10 52 25 0.8 1.2	ns ns nC nC nC v
$r_r$ $d_{(off)}$ $d_{g}$ $Q_g$ $Q_{gs}$ $Q_{gd}$ <b>Drain-So</b>	Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $I_D = 15 \text{ V},$ $I_D = 19 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_S = 2 \text{ A}$ (Note 2)		30 4 37 18 6 6 0.6	10 48 10 52 25 	ns ns nC nC nC

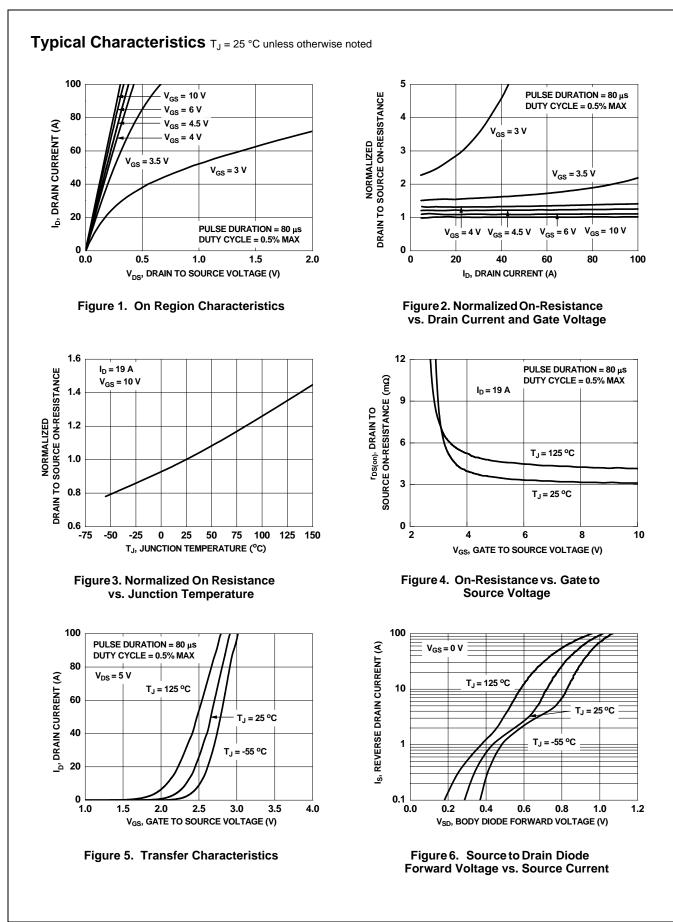
2. Pulse Test: Pulse Width < 300  $\mu \text{s},$  Duty cycle < 2.0%.

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3.  $E_{AS}$  of 66 mJ is based on starting  $T_J$  = 25 °C, L = 0.3 mH,  $I_{AS}$  = 21 A,  $V_{DD}$  = 27 V,  $V_{GS}$  = 10 V. 100% tested at L = 3 mH,  $I_{AS}$  = 10.2 A.

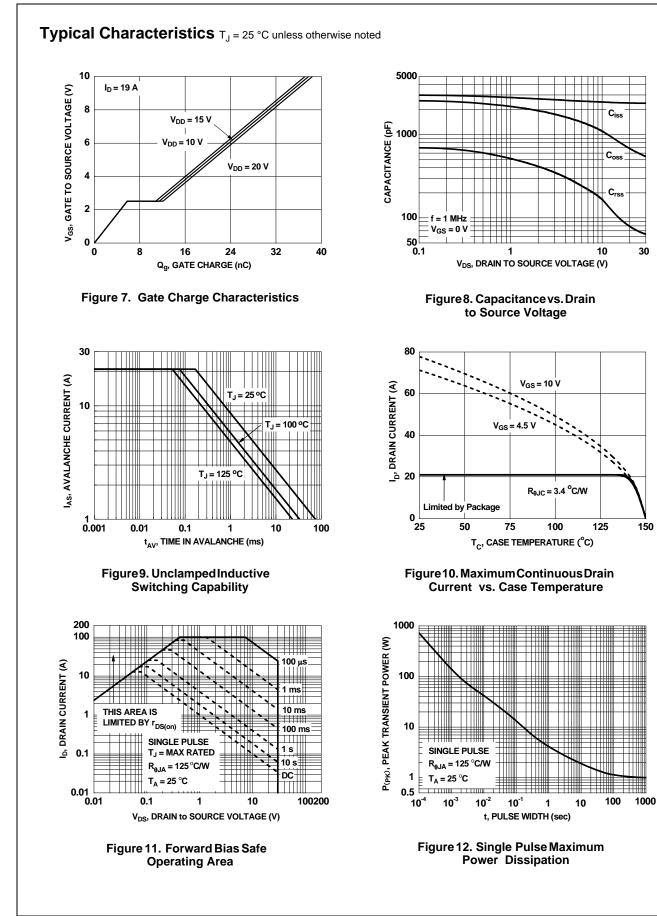
4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

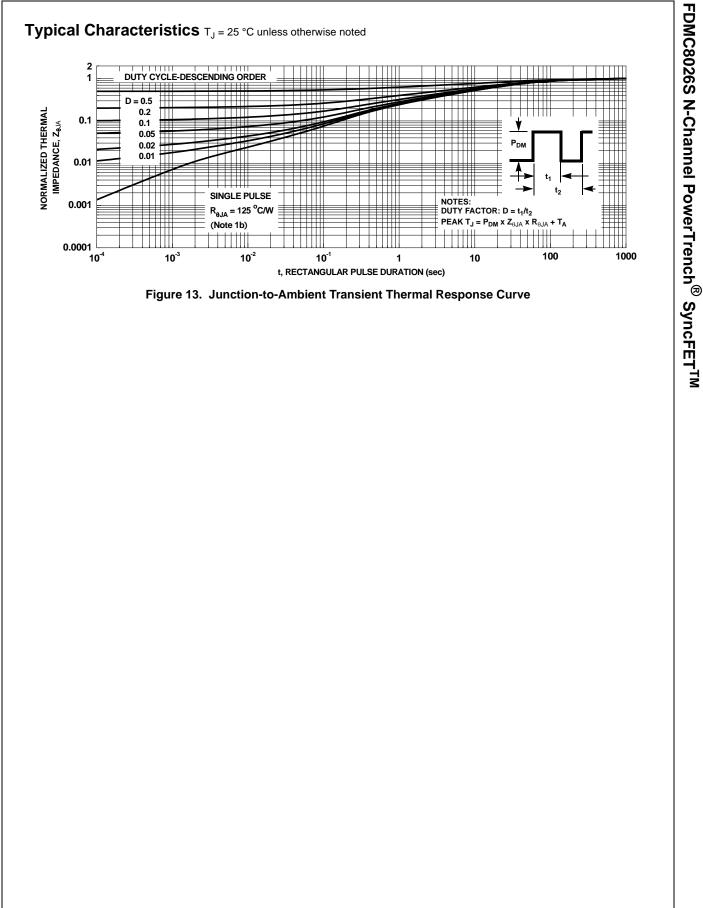
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# FDMC8026S N-Channel PowerTrench<sup>®</sup> SyncFET<sup>TM</sup>

### Typical Characteristics (continued)

### SyncFET<sup>™</sup> Schottky body diode Characteristics

Fairchild's SyncFET<sup>TM</sup> process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverse recovery characteristic of the FDMC8026S.

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

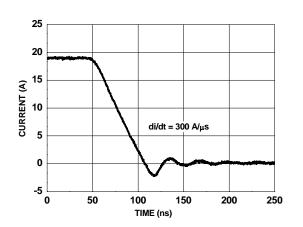
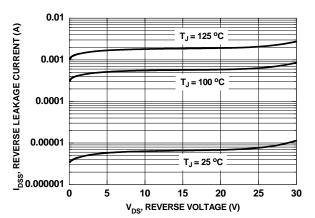
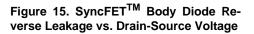
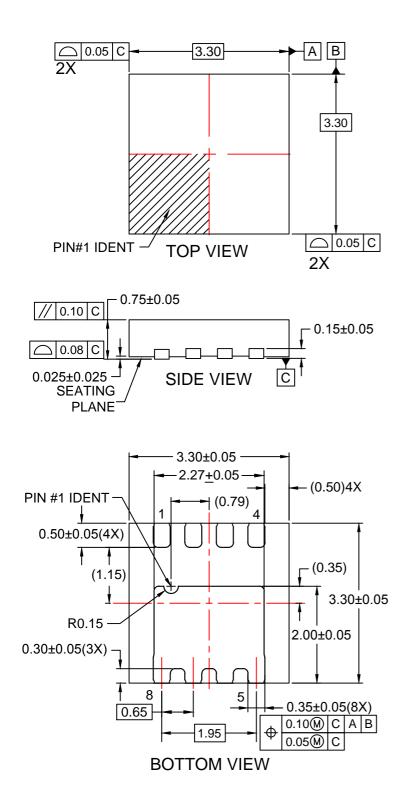
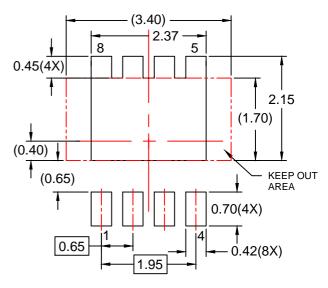


Figure 14. FDMC8026S SyncFET<sup>™</sup> Body Diode Reverse Recovery Characteristic









### RECOMMENDED LAND PATTERN

NOTES:

- A. DOES NOT CONFORM TO JEDEC REGISTRATION MO-229
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
- E. DRAWING FILENAME: MKT-MLP08Srev3.



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